ZDSD01G/02G/04G/08G/16G/32G/64G
SD NAND Datasheet

1. Introduction

Zetta SD NAND is an embedded storage solution designed in a LGA8 package form. The operation of SD NAND is similar to an SD card which is an industry standard.

SD NAND consists of NAND flash and a high-performance controller. 3.3V supply voltage is required for the NAND area (VCC). SD NAND is fully compliant with SD2.0 interface, which is utilized by most of general CPU. The advantages of the SD NAND include high quality, low power consumption and cost performance.
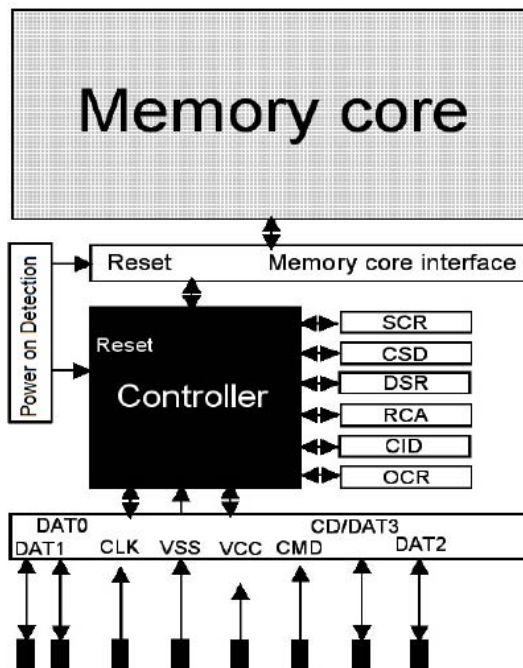
2. Product List

Capacity	Part number	Package	Size
1Gb (SLC)	ZDSD01GLGEAG	LGA8 (Land Grid Array)	8x6mm
2Gb (SLC)	ZDSD02GLGEAG	LGA8 (Land Grid Array)	8x6mm
4Gb (SLC)	ZDSD04GLGEAG	LGA8 (Land Grid Array)	8x6mm
8Gb (MLC)	ZDSD08GLGEAG	LGA8 (Land Grid Array)	8x6.2mm
16Gb (MLC)	ZDSD16GLGEGA	LGA8 (Land Grid Array)	8x6.2mm
32Gb (MLC)	ZDSD32GLGEGA	LGA8 (Land Grid Array)	8x6.2mm
64Gb (MLC)	ZDSD64GLGEGA	LGA8 (Land Grid Array)	9x12.5mm

Note：R/W Cycle：SLC(100,000)，MLC(6,000)

3. Features

√ Support up to 50Mhz clock frequency

√ Support 1/4 bit mode

√ Built-in HW ECC Engine and highly reliable NAND management mechanism

√ High Speed model, Speed class 4/class 6/class 8/class10 supported.

√ Smaller package LGA8 (Land Grid Array)

√ Operation Conditions   Temperature Range: Ta = -25℃ to +85℃

√ Storage Conditions   Temperature Range: Tstg = -40℃ to +85℃

4. Block Diagram

5. Pin Assignments

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          ●
    1  ▮              ▮  8
    2  ▮    Top View  ▮  7
    3  ▮              ▮  6
    4  ▮              ▮  5
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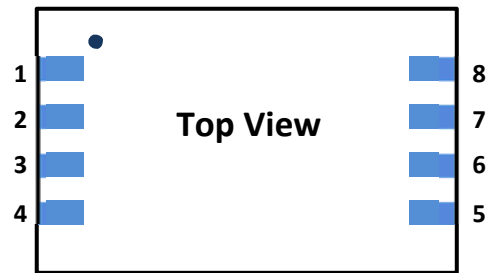
Pin No.	Pin name (SD mode)	Pin name (SPI mode)
1	SD2, I/O pin	NC, no connection
2	SD3, I/O pin	/CS, chip select
3	CLK, clock signal	CLK, clock signal
4	Vss, ground	Vss, groud
5	CMD, command signal	DI, data in
6	SD0, I/O pin	DO, data out
7	SD1, I/O pin	NC, no connection
8	Vdd, power supply	Vdd, power supply

6. Usage

6.1. Product Protocol

As SD NAND is the realize SD2.0 standard product, thus please refer to the SD2.0 related protocol: SD Physical Layer Specification Version 2.00.

6.2. DC Characteristics

Item		Symbol	MIN	MAX	Unit	Note
Supply voltage		VDD	2.7	3.6	V	
Input voltage	High Level	VIH	VDD*0.625	VDD+0.3	V	
	Low Level	VIL	VSS-0.3	VDD*0.25	V	
Output voltage	High Level	VOH	VDD*0.75	--	V	IOH=-2mA, VDD=VDDmin
	Low Level	VCL	--	VDD*0.125	V	IOL=2ma, VDD=VDDmin
Standby Current(*)		Icc1	--	20*	mA	VDD=3.6V, clock 25MHz
			--	0.2		VDD=3.0V, clock STOP, Ta=25° C
Operation Current(*)	Write	I	--	25	mA	3.6V/25MHz,50MHz
	Read	I	--	25		
Input voltage setup Time		Vrs	--	250	ms	

Note: Standby current max 20mA with CLOCK 25Mhz only based on 100 pcs samples

Peak Voltage and Leak Current

Item	Symbol	MIN	MAX	Unit	Note
Peak voltage on all lines		-0.3	VDD+0.3	V	
Input Leakage Current for all pins		-10	10	uA	
Output Leakage Current for all outputs		-10	10	uA	

Signal Capacitance

Pull up Resistance	RCMD/RDAT	10	100	k	
Total bus capacitance for each signal line	CL	-	40	pF	1 card CHOST+CBUS≤30pF
Card Capacitance for signal pin	CCARD	-	10	pF	
Pull up Resistance inside card (pin1)	RDAT3	10	90	k	
Capacity Connected to Power line	CC	-	5	pF	

Note: WP pull-up (Rwp) Value is depend on the Host Interface drive circuit.

7. Package Dimensions

LGA8 (SLC 8x6mm/MLC 8x6.2mm/MLC 9x12.5mm) (Land Grid Array)
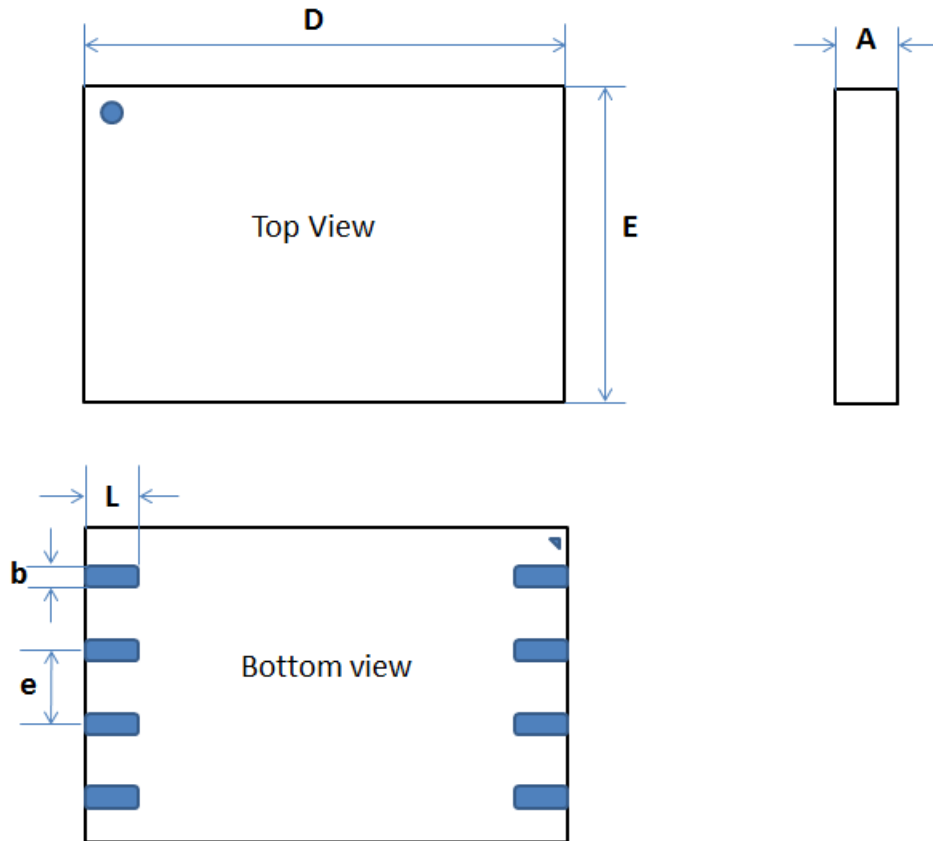
Dimensions:

Symbol		A	b	D	E-SLC	E-MLC	e	L
Unit								
Mm	**Min**	0.75	0.55	7.95	5.90	6.10		0.75
	Norm	0.80	0.60	8.00	6.00	6.20	1.27	0.80
	Max	0.85	0.65	8.05	6.10	6.30		0.85

8. Ordering Information

The ordering part number is formed by a valid combination of the following

ZD SD XXX   LG E A G

Company Prefix

ZD = Zetta

Product Family

SD = 2.7~ 3.6V SD2.0 NAND in package form

Product Density

01G = 1Gbit (128MByte)
02G = 2Gbit (256MByte)
04G = 4Gbit (512MByte)
08G = 8Gbit (1GByte)

Product Package

LG = LGA8 (Land Grid Array)

Temperature Grade

E = Extended (-30°C to +85°C)

Product Carrier

U = Tube; T = Tape & Reel; A = Tray

Green Code

G = Green/Reach Package
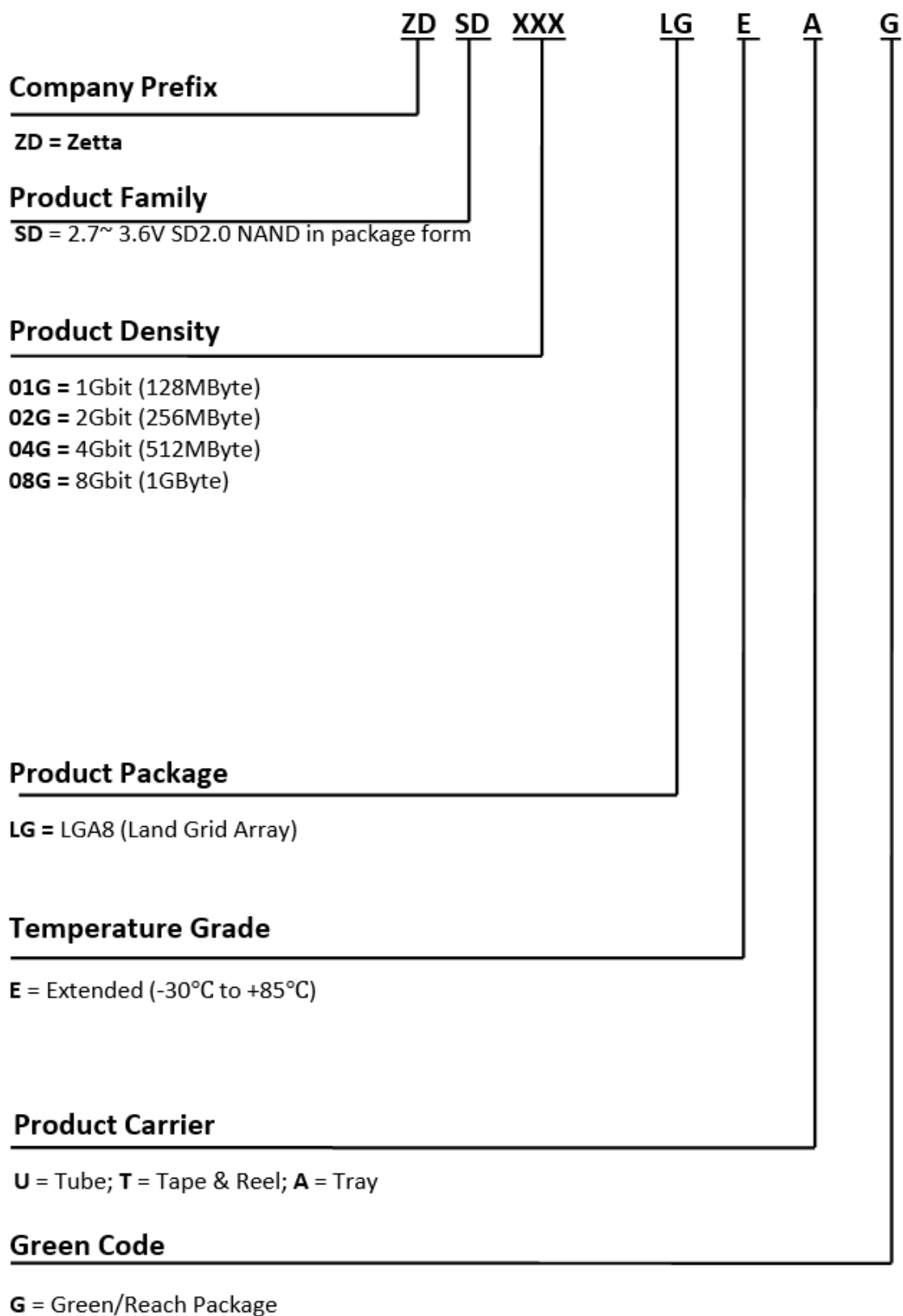
9. Revision History

Version No.	Change Description	Date
V1.0	Initial release, part number is based on extended temperature, LGA 8*6mm.	2020/06/02
V1.1	Add MLC SD Nand 8Gb, 16Gb, 32Gb and 64Gb.	2021/12/01